

## **STF260N4F7**

# N-channel 40 V, 1.95 mΩ typ., 90 A, STripFET™ F7 Power MOSFET in a TO-220FP package

Datasheet - preliminary data

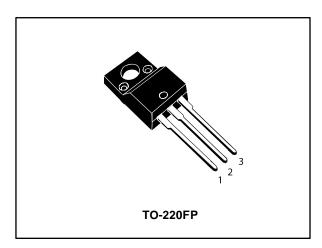
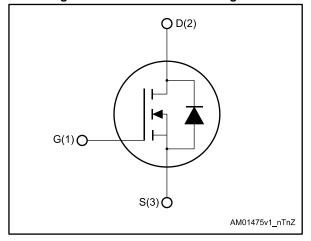


Figure 1: Internal schematic diagram



#### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>
STF260N4F7	40 V	2.5 mΩ	35 W

- Among the lowest R<sub>DS(on)</sub> on the market
- Excellent figure of merit (FoM)
- Low C<sub>rss</sub>/C<sub>iss</sub> ratio for EMI immunity
- High avalanche ruggedness

### **Applications**

Switching applications

#### **Description**

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

**Table 1: Device summary** 

Order code	Marking	Package	Packaging
STF260N4F7	260N4F7	TO-220FP	Tube

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STF260N4F7 Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	40	V
$V_{GS}$	Gate-source voltage	±20	V
$I_D$	Drain current (continuous) at T <sub>C</sub> = 25 °C	90	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	64	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	360	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	35	W
V <sub>iso</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1s; $T_C$ = 25 °C)	2.5	kV
T <sub>stg</sub>	Storage temperature	-55 to 175	°C
TJ	Operation junction temperature	-55 10 175	

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	4.29	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max	62.5	°C/W

<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area

Electrical characteristics STF260N4F7

## 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Table 4: On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Uni t
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40			V
	Zero gate voltage	$V_{GS} = 0 \text{ V}, V_{DS} = 40 \text{ V}$			1	μΑ
I <sub>DSS</sub>	drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 40 \text{ V}$ $T_C = 125 \text{ °C}$			100	μΑ
I <sub>GSS</sub>	Gate-body leakage current	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = + 20 V			100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_D = 60 \text{ A}$		1.95	2.5	mΩ

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		ı	5640	ı	pF
C <sub>oss</sub>	Output capacitance	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	1	2370	ı	pF
C <sub>rss</sub>	Reverse transfer capacitance	VGS - 0 V, VDS - 20 V, I - I WII IZ		34	-	pF
$Q_g$	Total gate charge	$V_{DD} = 20 \text{ V}, I_D = 120 \text{ A},$	-	67	-	nC
$Q_gs$	Gate-source charge	V <sub>GS</sub> = 10 V	•	31	ı	nC
$Q_gd$	Gate-drain charge	(see Figure 3: "Test circuit for gate charge behavior")	-	10	-	nC

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 20 \text{ V}, I_D = 60 \text{ A},$	-	30	-	ns
t <sub>r</sub>	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$	-	21	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 2: "Test circuit for resistive load switching times" and Figure 7: "Switching time waveform"	-	42	-	ns
t <sub>f</sub>	Fall time	ame wavelenn	-	13	-	ns

Table 7: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 120 A	-	-	1.1	>
t <sub>rr</sub>	Reverse recovery time		-	68		ns
Qrr	Reverse recovery charge	I <sub>SD</sub> = 120 A, di/dt = 100 A/μs V <sub>DD</sub> = 32 V (see <i>Figure 4: "Test circuit for inductive load switching and diode</i>	-	98		nC
I <sub>RRM</sub>	Reverse recovery current	recovery times")	-	3		А

#### Notes



 $<sup>^{(1)}\</sup>text{Pulsed:}$  pulse duration = 300  $\mu\text{s,}$  duty cycle 1.5%

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## 3 Test circuits

Figure 2: Test circuit for resistive load

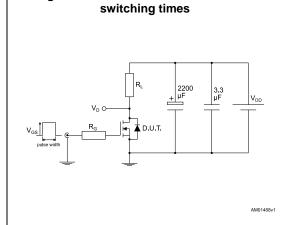


Figure 3: Test circuit for gate charge behavior

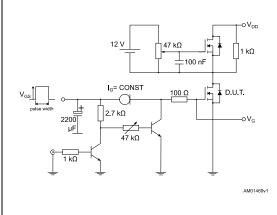


Figure 4: Test circuit for inductive load switching and diode recovery times

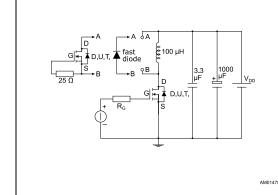


Figure 5: Unclamped inductive load test circuit

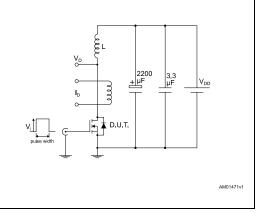


Figure 6: Unclamped inductive waveform

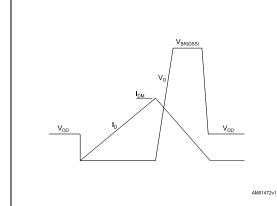
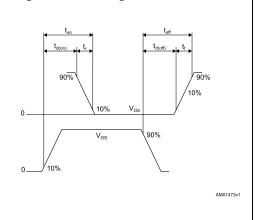


Figure 7: Switching time waveform



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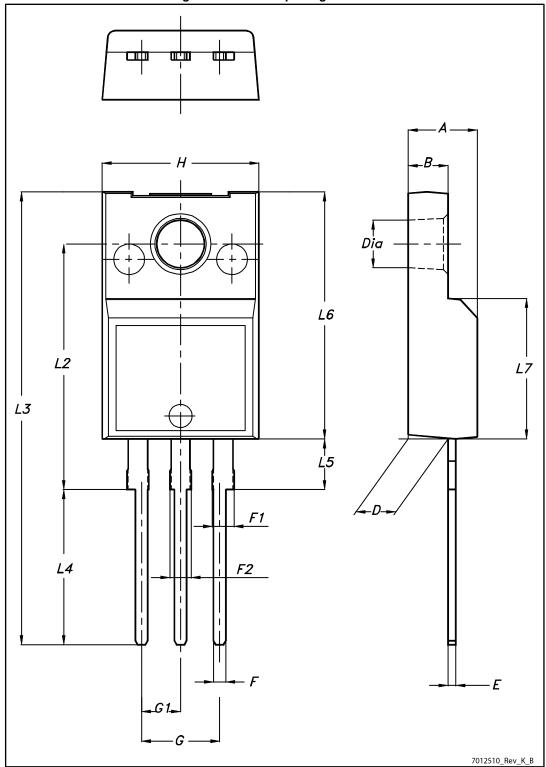
## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



# 4.1 TO-220FP package information

Figure 8: TO-220FP package outline



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Table 8: TO-220FP package mechanical data

	mm				
Dim.	Min.	Тур.	Max.		
А	4.4		4.6		
В	2.5		2.7		
D	2.5		2.75		
Е	0.45		0.7		
F	0.75		1		
F1	1.15		1.70		
F2	1.15		1.70		
G	4.95		5.2		
G1	2.4		2.7		
Н	10		10.4		
L2		16			
L3	28.6		30.6		
L4	9.8		10.6		
L5	2.9		3.6		
L6	15.9		16.4		
L7	9		9.3		
Dia	3		3.2		

Revision history STF260N4F7

# 5 Revision history

**Table 9: Document revision history** 

Date	Revision	Changes
13-Oct-2015	1	Initial release.

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